

# DATA SHEET

## THICK FILM CHIP RESISTORS

Precision grade

RE series

0.1%, 0.5%, 1%, TC 50

sizes 0201/0402/0603/0805/1206

RoHS compliant & Halogen Free



**YAGEO**  
**Phycomp**

Product specification – June 01, 2017 V.6



**SCOPE**

This specification describes RE0201 to RE1206 ultra precision chip resistors with lead-free terminations made by thick film process.

**APPLICATIONS**

- Converters
- Printer equipment
- Server board
- Telecom
- Consumer

**FEATURES**

- Halogen Free Epoxy
- RoHS compliant
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Non-forbidden material used in products/production
- Moisture sensitivity level: MSL 1

**ORDERING INFORMATION - GLOBAL PART NUMBER & 12NC**

Both part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

**YAGEO BRAND ordering code****GLOBAL PART NUMBER (PREFERRED)**

RE XXXX X X X XX XXXX L  
 (1) (2) (3) (4) (5) (6) (7)

**(1) SIZE**

0201 / 0402 / 0603 / 0805 / 1206

**(2) TOLERANCE**

B =  $\pm 0.1\%$

D =  $\pm 0.5\%$

F =  $\pm 1\%$

**(3) PACKAGING TYPE**

R = Paper/PE taping reel

**(4) TEMPERATURE COEFFICIENT OF RESISTANCE**

E =  $\pm 50$  ppm/ $^{\circ}\text{C}$

**(5) TAPING REEL**

07 = 7 inch dia. Reel

10 = 10 inch dia. Reel

13 = 13 inch dia. Reel

**(6) RESISTANCE VALUE**

There are 2~4 digits indicated the resistor value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. 1K2, not 1K20.

Detailed resistance rules show in table of "Resistance rule of global part number".

**(7) DEFAULT CODE**

Letter L is system default code for order only (Note)

**Resistance rule of global part number**

| Resistance code rule            | Example                                     |
|---------------------------------|---------------------------------------------|
| XXRX<br>(10 to 97.6 $\Omega$ )  | 10R = 10 $\Omega$<br>97R6 = 97.6 $\Omega$   |
| XXXR<br>(100 to 976 $\Omega$ )  | 100R = 100 $\Omega$                         |
| XKXX<br>(1 to 9.76 K $\Omega$ ) | 1K = 1,000 $\Omega$<br>9K76 = 9760 $\Omega$ |
| XMXX<br>(1 M $\Omega$ )         | 1M = 1,000,000 $\Omega$                     |

**ORDERING EXAMPLE**

The ordering code of a RE0603 chip resistor, TC 50 value 56 $\Omega$  with  $\pm 0.5\%$  tolerance, supplied in 7-inch tape reel is: RE0603DRE0756RL.

**NOTE**

1. All our R-Chip products meet RoHS compliant and Halogen Free. "LFP" of the internal 2D reel label mentions "Lead Free Process"
2. On customized label, "LFP" or specific symbol can be printed

## MARKING

### RE0805 / RE1206

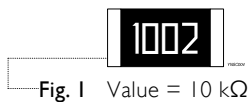


Fig. 1 Value = 10 kΩ

Either resistance in E-24 or E-96: 4 digits

First three digits for significant figure and 4th digit for number of zeros

### RE0603

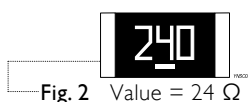


Fig. 2 Value = 24 Ω

1%, 0.5%, 0.1% E24 exception values 10/11/13/15/20/75 of E24 series

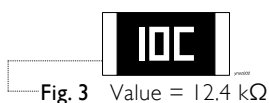


Fig. 3 Value = 12.4 kΩ

1%, 0.5%, 0.1% E96 refer to EIA-96 marking method, including values 10/11/13/15/20/75 of E24 series

### RE0201/0402

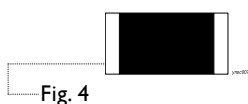


Fig. 4

No marking

For further marking information, please see special data sheet “Chip resistors marking”.

## CONSTRUCTION

The resistors are constructed out of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive layer. The resistive layer is adjusted to give the approximate required resistance and laser cutting of this resistive layer that achieves tolerance trims the value. The resistive layer is covered with a protective coat and printed with the resistance value. Finally, the two external terminations (matte tin) are added. See fig. 5.

## DIMENSION

Table I For outlines see fig. 5

| TYPE   | L (mm)     | W (mm)     | H (mm)     | I <sub>1</sub> (mm) | I <sub>2</sub> (mm) |
|--------|------------|------------|------------|---------------------|---------------------|
| RE0201 | 0.60 ±0.03 | 0.30 ±0.03 | 0.23 ±0.03 | 0.10 ±0.05          | 0.15 ±0.05          |
| RE0402 | 1.00 ±0.05 | 0.50 ±0.05 | 0.32 ±0.05 | 0.20 ±0.10          | 0.25 ±0.10          |
| RE0603 | 1.60 ±0.10 | 0.80 ±0.10 | 0.45 ±0.10 | 0.25 ±0.15          | 0.25 ±0.15          |
| RE0805 | 2.00 ±0.10 | 1.25 ±0.10 | 0.50 ±0.10 | 0.35 ±0.20          | 0.35 ±0.20          |
| RE1206 | 3.10 ±0.10 | 1.60 ±0.10 | 0.55 ±0.10 | 0.45 ±0.20          | 0.40 ±0.20          |

## OUTLINES

For dimension see Table I

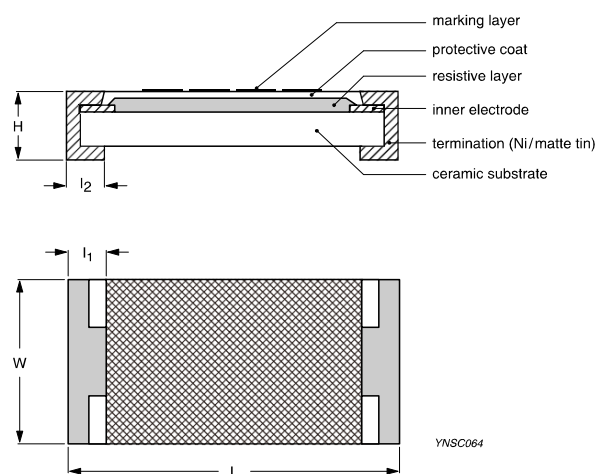


Fig. 5 Chip resistor outlines

**ELECTRICAL CHARACTERISTICS**

Table 2

| TYPE   | RESISTANCE RANGE<br>(E24/E96) | OPERATING TEMPERATURE RANGE | POWER RATING | MAXIMUM WORKING VOLTAGE | DIELECTRIC WITHSTAND VOLTAGE | MAXIMUM OVERLOAD VOLTAGE | TEMPERATURE COEFFICIENT OF RESISTANCE |
|--------|-------------------------------|-----------------------------|--------------|-------------------------|------------------------------|--------------------------|---------------------------------------|
| RE0201 | 100 $\Omega$ to 1 M $\Omega$  | -55 °C to +155 °C           | 1/20W        | 25 V                    | 50 V                         | 50 V                     | $\pm 50$ ppm/°C                       |
| RE0402 | 10 $\Omega$ to 1 M $\Omega$   | -55 °C to +155 °C           | 1/16 W       | 50 V                    | 100 V                        | 100 V                    | $\pm 50$ ppm/°C                       |
| RE0603 | 10 $\Omega$ to 1 M $\Omega$   | -55 °C to +155 °C           | 1/10 W       | 75 V                    | 150 V                        | 150 V                    | $\pm 50$ ppm/°C                       |
| RE0805 | 10 $\Omega$ to 1 M $\Omega$   | -55 °C to +155 °C           | 1/8 W        | 150 V                   | 300 V                        | 300 V                    | $\pm 50$ ppm/°C                       |
| RE1206 | 10 $\Omega$ to 1 M $\Omega$   | -55 °C to +155 °C           | 1/4 W        | 200 V                   | 500 V                        | 400 V                    | $\pm 50$ ppm/°C                       |

**NOTE**

The maximum working voltage that may be continuously applied to the resistor element, see “IEC publication 60115-8”

**FOOTPRINT AND SOLDERING PROFILES**

For recommended footprint and soldering profiles, please see the special data sheet “Chip resistors mounting”.

**PACKING STYLE AND PACKAGING QUANTITY**

Table 3 Packing style and packaging quantity

| PACKING STYLE            | REEL DIMENSION | RE0201 | RE0402 | RE0603 | RE0805 | RE1206 |
|--------------------------|----------------|--------|--------|--------|--------|--------|
| Paper/PE taping reel (R) | 7" (178 mm)    | 10,000 | 10,000 | 5,000  | 5,000  | 5,000  |
|                          | 10" (254 mm)   | 20,000 | 20,000 | 10,000 | 10,000 | 10,000 |
|                          | 13" (330 mm)   | 50,000 | 50,000 | 20,000 | 20,000 | 20,000 |

**NOTE**

1. For Paper/PE tape and reel specification/dimensions, please see the special data sheet “Chip resistors packing”

**FUNCTIONAL DESCRIPTION****POWER RATING**

Each type rated power at 70°C:

RE0201=1/20W, RE0402=1/16W, RE0603=1/10W,

RE0805=1/8 W, RE1206=1/4W

**RATED VOLTAGE**

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{P \times R}$$

or max. working voltage whichever is less

Where

V=Continuous rated DC or  
AC (rms) working voltage (V)

P=Rated power (W)

R=Resistance value ( $\Omega$ )

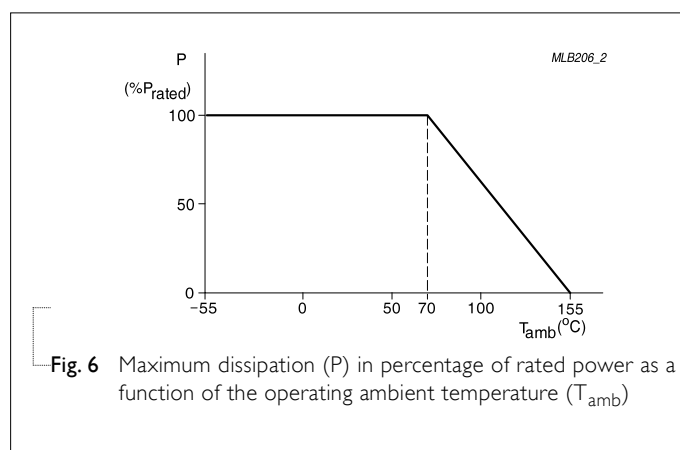


Fig. 6 Maximum dissipation (P) in percentage of rated power as a function of the operating ambient temperature ( $T_{amb}$ )

**TESTS AND REQUIREMENTS****Table 4** Test condition, procedure and requirements

| TEST                      | TEST METHOD             | PROCEDURE                                                                                                                                          | REQUIREMENTS                      |
|---------------------------|-------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------|
| Life/Endurance            | IEC 60115-1 4.25.1      | At 70±2 °C for 1,000 hours, RCWV applied for                                                                                                       | ±(3%+0.05 Ω)                      |
|                           | MIL-STD-202 Method 108A | 1.5 hours on, 0.5 hour off, still air required                                                                                                     |                                   |
| High Temperature Exposure | IEC 60068-2-2           | 1,000 hours at 155±5 °C, unpowered                                                                                                                 | ±(3%+0.05 Ω)                      |
|                           | MIL-STD-202 Method 108A |                                                                                                                                                    |                                   |
| Moisture Resistance       | MIL-STD-202 Method 106G | Each temperature / humidity cycle is defined at 8 hours, 3 cycles / 24 hours for 10d. with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered | ±(3%+0.05 Ω)                      |
|                           |                         | Parts mounted on test-boards, without condensation on parts<br>Measurement at 24±2 hours after test conclusion                                     |                                   |
| Thermal Shock             | MIL-STD-202 Method 107G | -55/+125 °C<br>Number of cycles required is 300.<br>Devices mounted<br>Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air    | ±(1%+0.05 Ω)                      |
|                           |                         |                                                                                                                                                    |                                   |
| Short Time Overload       | IEC60115-1 4.13         | 2.5 times of rated voltage or maximum overload voltage whichever is less for 5 sec at room temperature                                             | ±(1%+0.05 Ω)<br>No visible damage |
| Board Flex/Bending        | IEC 60115-1 4.33        | Chips mounted on a 90mm glass epoxy resin PCB (FR4)                                                                                                | ±(1%+0.05 Ω)<br>No visible damage |
|                           |                         | Bending: see table 5 for each size<br>Bending time: 60±5 seconds                                                                                   |                                   |

| TEST                           | TEST METHOD        | PROCEDURE                                                                                                                                                                                                                       | REQUIREMENTS                                    |
|--------------------------------|--------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------|
| Humidity                       | IEC 60115-1 4.24.2 | Steady state for 1000 hours at 40 °C / 95% R.H. RCWV applied for 1.5 hours on and 0.5 hour off                                                                                                                                  | $\pm(3\%+0.05 \Omega)$                          |
| Solderability<br>- Wetting     | J-STD-002 test B   | Electrical Test not required<br>Magnification 50X<br>SMD conditions:<br>1 <sup>st</sup> step: method B, aging 4 hours at 155°C dry heat<br>2 <sup>nd</sup> step: leadfree solder bath at 245±3°C<br>Dipping time: 3±0.5 seconds | Well tinned (≥95% covered)<br>No visible damage |
| - Leaching                     | J-STD-002 test D   | Leadfree solder, 260 °C, 30 seconds immersion time                                                                                                                                                                              | No visible damage                               |
| - Resistance to Soldering Heat | IEC 60115-1 4.18   | Condition B, no pre-heat of samples.<br>Leadfree solder, 260 °C, 10 seconds immersion time<br>Procedure 2 for SMD: devices fluxed and cleaned with isopropanol                                                                  | $\pm(1\%+0.05 \Omega)$<br>No visible damage     |

Table 5 Bending for sizes 0201 to 1206

| TYPE               | RE0201 | RE0402 | RE0603 | RE0805 | RE1206 |
|--------------------|--------|--------|--------|--------|--------|
| Specification (mm) | 5      | 5      | 3      | 3      | 2      |

**REVISION HISTORY**

| REVISION  | DATE          | CHANGE NOTIFICATION | DESCRIPTION                                                                                                                            |
|-----------|---------------|---------------------|----------------------------------------------------------------------------------------------------------------------------------------|
| Version 6 | May 31, 2017  | -                   | -Add 10" packing                                                                                                                       |
| Version 5 | Feb 24, 2017  | -                   | -Delete 125°C in derating curve                                                                                                        |
| Version 4 | May 03, 2016  | -                   | -Update 0201 resistor value                                                                                                            |
| Version 3 | Jan. 26, 2015 | -                   | - Update Working Voltage                                                                                                               |
| Version 2 | May 11, 2015  | -                   | - Update test and requirements                                                                                                         |
| Version 1 | Jan 23, 2014  | -                   | - Add RE0201<br>- Add 0.1%<br>- Update TEST AND REQUIREMENTS, add Humidity test                                                        |
| Version 0 | Dec 10, 2010  | -                   | - New datasheet for thick film ultra precision chip resistors sizes of 0402/0603/0805/1206, 0.5%, 1%, TC50 with lead-free terminations |

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